

TOSHIBA Field Effect Transistor Silicon N-Channel MOS Type ( $\pi$ -MOSIV)**2SK3878**

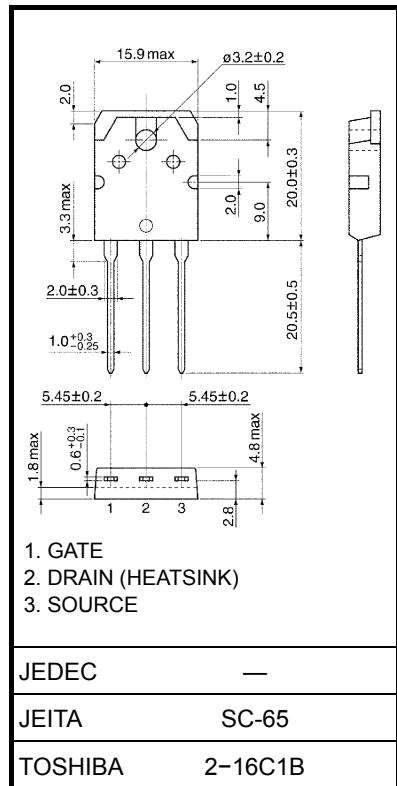
## Switching Regulator Applications

Unit: mm

- Low drain-source ON resistance:  $R_{DS(ON)} = 1.0 \Omega$  (typ.)
- High forward transfer admittance:  $|Y_{fs}| = 7.0 \text{ S}$  (typ.)
- Low leakage current:  $I_{DSS} = 100 \mu\text{A}$  (max) ( $V_{DS} = 720 \text{ V}$ )
- Enhancement model:  $V_{th} = 2.0 \sim 4.0 \text{ V}$  ( $V_{DS} = 10 \text{ V}$ ,  $I_D = 1 \text{ mA}$ )

**Absolute Maximum Ratings ( $T_a = 25^\circ\text{C}$ )**

Characteristic	Symbol	Rating	Unit
Drain-source voltage	$V_{DSS}$	900	V
Drain-gate voltage ( $R_{GS} = 20 \text{ k}\Omega$ )	$V_{DGR}$	900	V
Gate-source voltage	$V_{GSS}$	$\pm 30$	V
Drain current	DC (Note 1)	$I_D$	A
	Pulse (Note 1)	$I_{DP}$	
Drain power dissipation ( $T_c = 25^\circ\text{C}$ )	$P_D$	150	W
Single pulse avalanche energy (Note 2)	$E_{AS}$	778	mJ
Avalanche current	$I_{AR}$	9	A
Repetitive avalanche energy (Note 3)	$E_{AR}$	15	mJ
Channel temperature	$T_{ch}$	150	$^\circ\text{C}$
Storage temperature range	$T_{stg}$	-55~150	$^\circ\text{C}$



Weight: 4.6 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

**Thermal Characteristics**

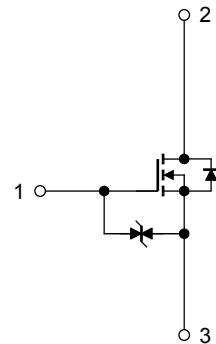
Characteristic	Symbol	Max	Unit
Thermal resistance, channel to case	$R_{th}(ch-c)$	0.833	$^\circ\text{C}/\text{W}$
Thermal resistance, channel to ambient	$R_{th}(ch-a)$	50	$^\circ\text{C}/\text{W}$

Note 1: Ensure that the channel temperature does not exceed  $150^\circ\text{C}$  during use of the device.

Note 2:  $V_{DD} = 90 \text{ V}$ ,  $T_{ch} = 25^\circ\text{C}$ ,  $L = 17.6 \text{ mH}$ ,  $R_G = 25 \Omega$ ,  $I_{AR} = 9 \text{ A}$

Note 3: Repetitive rating: pulse width limited by max junction temperature

This transistor is an electrostatic-sensitive device. Handle with care.



Electrical Characteristics ( $T_a = 25^\circ\text{C}$ )

Characteristic	Symbol	Test Condition	Min	Typ.	Max	Unit
Gate leakage current	$I_{GSS}$	$V_{GS} = \pm 30\text{ V}, V_{DS} = 0\text{ V}$	—	—	$\pm 10$	$\mu\text{A}$
Drain-source breakdown voltage	$V_{(\text{BR})\text{ GSS}}$	$I_G = \pm 10\text{ }\mu\text{A}, V_{DS} = 0\text{ V}$	$\pm 30$	—	—	V
Drain cutoff current	$I_{DSS}$	$V_{DS} = 720\text{ V}, V_{GS} = 0\text{ V}$	—	—	100	$\mu\text{A}$
Drain-source breakdown voltage	$V_{(\text{BR})\text{ DSS}}$	$I_D = 10\text{ mA}, V_{GS} = 0\text{ V}$	900	—	—	V
Gate threshold voltage	$V_{th}$	$V_{DS} = 10\text{ V}, I_D = 1\text{ mA}$	2.0	—	4.0	V
Drain-source ON resistance	$R_{DS}\text{ (ON)}$	$V_{GS} = 10\text{ V}, I_D = 4\text{ A}$	—	1.0	1.3	$\Omega$
Forward transfer admittance	$ Y_{fs} $	$V_{DS} = 15\text{ V}, I_D = 4\text{ A}$	3.5	7.0	—	S
Input capacitance	$C_{iss}$	$V_{DS} = 25\text{ V}, V_{GS} = 0\text{ V}, f = 1\text{ MHz}$	—	2200	—	pF
Reverse transfer capacitance	$C_{rss}$		—	45	—	
Output capacitance	$C_{oss}$		—	190	—	
Switching time	Rise time	$t_r$	 Duty $\leq 1\%$ , $t_w = 10\text{ }\mu\text{s}$	—	25	—
	Turn-on time	$t_{on}$		—	65	—
	Fall time	$t_f$		—	20	—
	Turn-off time	$t_{off}$		—	120	—
Total gate charge (gate-source plus gate-drain)	$Q_g$	$V_{DD} \approx 400\text{ V}, V_{GS} = 10\text{ V}, I_D = 9\text{ A}$	—	60	—	nC
Gate-source charge	$Q_{gs}$		—	34	—	
Gate-drain ("Miller") charge	$Q_{gd}$		—	26	—	

Source-Drain Ratings and Characteristics ( $T_a = 25^\circ\text{C}$ )

Characteristic	Symbol	Test Condition	Min	Typ.	Max	Unit
Continuous drain reverse current (Note 1)	$I_{DR}$	—	—	—	9	A
Pulse drain reverse current (Note 1)	$I_{DRP}$	—	—	—	27	A
Forward voltage (diode)	$V_{DSF}$	$I_{DR} = 9\text{ A}, V_{GS} = 0\text{ V}$	—	—	-1.7	V
Reverse recovery time	$t_{rr}$	$I_{DR} = 9\text{ A}, V_{GS} = 0\text{ V},$ $dI_{DR}/dt = 100\text{ A}/\mu\text{s}$	—	1.4	—	$\mu\text{s}$
Reverse recovery charge	$Q_{rr}$		—	16	—	$\mu\text{C}$

## Marking

